

Molex VITA 66.1 Optical MT Backplane Interconnect System

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[Molex Incorporated](#) [1] (Lisle, IL) has launched the VITA 66.1 ruggedized optical MT backplane interconnect solution for high-density military, aerospace, and commercial embedded system applications. Features include:

- Availability with 8, 12, or 24 fibers in standard singlemode or multimode and VersaBeam (expanded beam) MT ferrule options for design flexibility.
- A robust aluminum housing.
- An operating temperature range from -50° to +105°C.
- ANSI-ratified 66.1 compliance.

For more information visit www.molex.com [1].

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http://www.wirelessdesignmag.com/product-releases/2013/03/molex-vita-661-optical-mt-backplane-interconnect-system?qt-blogs=0&qt-digital_editions=0

Links:

[1] <http://www.molex.com>